



**ALPHA & OMEGA**  
SEMICONDUCTOR

**AON7462**

**300V,2.5A N-Channel MOSFET**

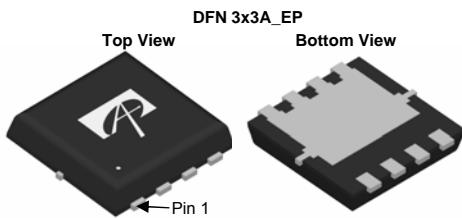
### General Description

The AON7462 is fabricated using an advanced high voltage MOSFET process that is designed to deliver high levels of performance and robustness in popular AC-DC applications. By providing low  $R_{DS(on)}$ ,  $C_{iss}$  and  $C_{rss}$  along with guaranteed avalanche capability this device can be adopted quickly into new and existing offline power supply designs. This device is ideal for boost converters and synchronous rectifiers for consumer, telecom, industrial power supplies and LED backlighting.

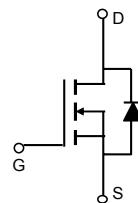
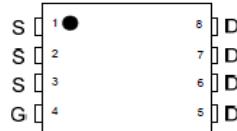
### Product Summary

$V_{DS}$	350V@150°C
$I_D$ (at $V_{GS}=10V$ )	2.5A
$R_{DS(ON)}$ (at $V_{GS}=10V$ )	< 1.5Ω

100% UIS Tested!  
100%  $R_g$  Tested!



### Top View



### Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	$V_{DS}$	300	V
Gate-Source Voltage	$V_{GS}$	$\pm 30$	V
Continuous Drain Current <sup>B</sup>	$I_D$	2.5	A
$T_C=100^\circ C$	$I_D$	1.6	
Pulsed Drain Current <sup>C</sup>	$I_{DM}$	7.2	
Continuous Drain Current	$I_{DSM}$	0.9	A
$T_A=70^\circ C$	$I_{DSM}$	0.7	
Avalanche Current <sup>C</sup>	$I_{AR}$	1.4	A
Repetitive avalanche energy <sup>C</sup>	$E_{AR}$	29	mJ
Single pulsed avalanche energy <sup>G</sup>	$E_{AS}$	58	mJ
Peak diode recovery dv/dt	dv/dt	5	V/ns
Power Dissipation <sup>B</sup>	$P_D$	25	W
$T_C=100^\circ C$	$P_D$	10	W
Power Dissipation <sup>A</sup>	$P_{DSM}$	3.1	W
$T_A=70^\circ C$	$P_{DSM}$	2	
Junction and Storage Temperature Range	$T_J, T_{STG}$	-50 to 150	°C

### Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient <sup>A</sup>	$R_{θJA}$	30	40	°C/W
$t \leq 10s$		60	75	°C/W
Maximum Junction-to-Ambient <sup>AD</sup>	Steady-State			
Maximum Junction-to-Case	Steady-State	$R_{θJC}$	4.2	5 °C/W

**Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>STATIC PARAMETERS</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$I_D=250\mu\text{A}, V_{GS}=0\text{V}, T_J=25^\circ\text{C}$	300			V
		$I_D=250\mu\text{A}, V_{GS}=0\text{V}, T_J=150^\circ\text{C}$		350		
$\text{BV}_{\text{DSS}}/\Delta T_J$	Zero Gate Voltage Drain Current	$I_D=250\mu\text{A}, V_{GS}=0\text{V}$		0.3		$\text{V}/^\circ\text{C}$
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{DS}=300\text{V}, V_{GS}=0\text{V}$		1		$\mu\text{A}$
		$V_{DS}=240\text{V}, T_J=125^\circ\text{C}$		10		
$I_{\text{GSS}}$	Gate-Body leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm 30\text{V}$			$\pm 100$	nA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{DS}=5\text{V}, I_D=250\mu\text{A}$	3.5	4.2	4.5	V
$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}, I_D=0.9\text{A}$		1.2	1.5	$\Omega$
$g_{\text{FS}}$	Forward Transconductance	$V_{DS}=40\text{V}, I_D=0.9\text{A}$		1.5		S
$V_{\text{SD}}$	Diode Forward Voltage	$I_S=1\text{A}, V_{GS}=0\text{V}$		0.8	1	V
$I_S$	Maximum Body-Diode Continuous Current				2.5	A
$I_{\text{SM}}$	Maximum Body-Diode Pulsed Current				9	A
<b>DYNAMIC PARAMETERS</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=25\text{V}, f=1\text{MHz}$	155	197	240	pF
$C_{\text{oss}}$	Output Capacitance		20	30	40	pF
$C_{\text{rss}}$	Reverse Transfer Capacitance			2		pF
$R_g$	Gate resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$	1.9	3.8	5.7	$\Omega$
<b>SWITCHING PARAMETERS</b>						
$Q_g$	Total Gate Charge	$V_{GS}=10\text{V}, V_{DS}=240\text{V}, I_D=0.9\text{A}$	3.5	4.6	5.6	nC
$Q_{\text{gs}}$	Gate Source Charge			1.3		nC
$Q_{\text{gd}}$	Gate Drain Charge			1.5		nC
$t_{\text{D(on)}}$	Turn-On Delay Time	$V_{GS}=10\text{V}, V_{DS}=150\text{V}, I_D=0.9\text{A}, R_G=25\Omega$		17		ns
$t_r$	Turn-On Rise Time			8		ns
$t_{\text{D(off)}}$	Turn-Off Delay Time			26		ns
$t_f$	Turn-Off Fall Time			13		ns
$t_{\text{rr}}$	Body Diode Reverse Recovery Time	$I_F=0.9\text{A}, dI/dt=100\text{A}/\mu\text{s}, V_{DS}=100\text{V}$	62	95	125	ns
$Q_{\text{rr}}$	Body Diode Reverse Recovery Charge	$I_F=0.9\text{A}, dI/dt=100\text{A}/\mu\text{s}, V_{DS}=100\text{V}$	0.14	0.22	0.3	$\mu\text{C}$

A. The value of  $R_{\text{IJ(A)}}$  is measured with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The Power Dissipation  $P_{\text{DSM}}$  is based on  $R_{\text{IJ(A)}}$   $t \leqslant 10\text{s}$  value and the maximum allowed junction temperature of  $150^\circ\text{C}$ . The value in any given application depends on the user's specific board design.

B. The power dissipation  $P_D$  is based on  $T_{J(\text{MAX})}=150^\circ\text{C}$ , using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Repetitive rating, pulse width limited by junction temperature  $T_{J(\text{MAX})}=150^\circ\text{C}$ . Ratings are based on low frequency and duty cycles to keep initial  $T_J=25^\circ\text{C}$ .

D. The  $R_{\text{IJ(A)}}$  is the sum of the thermal impedance from junction to case  $R_{\text{IJC}}$  and case to ambient.

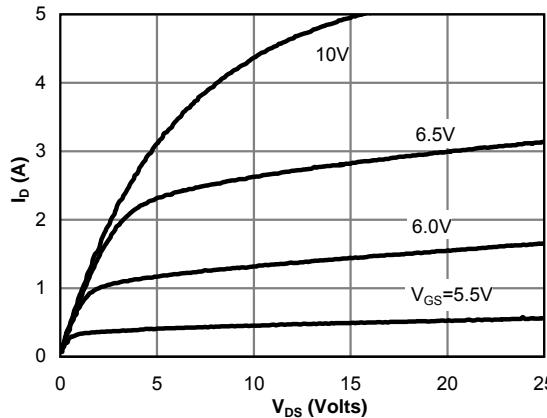
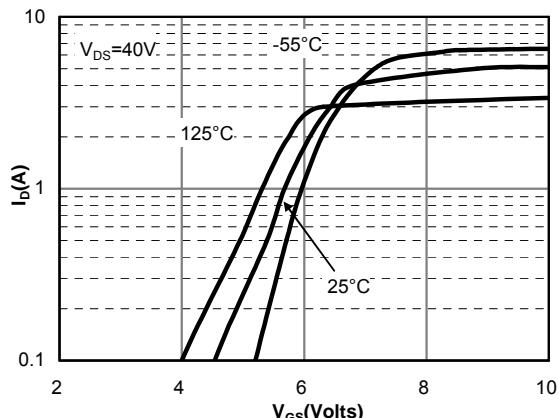
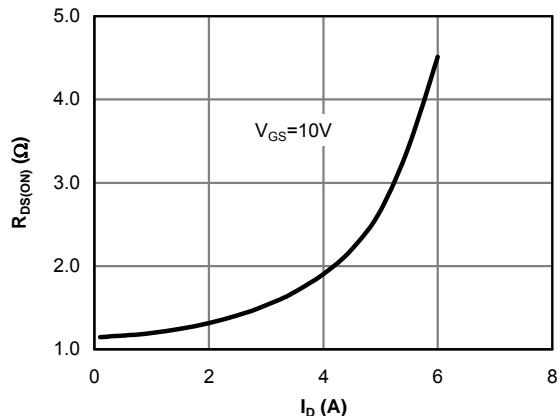
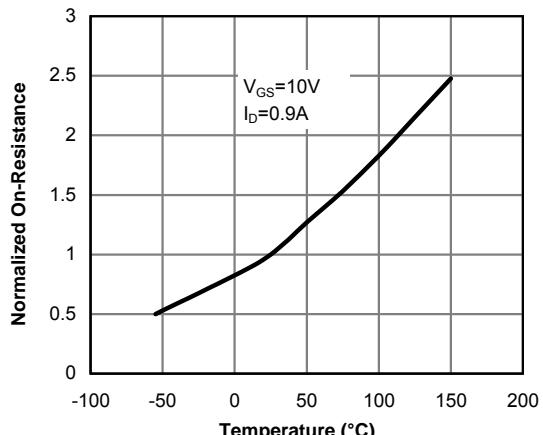
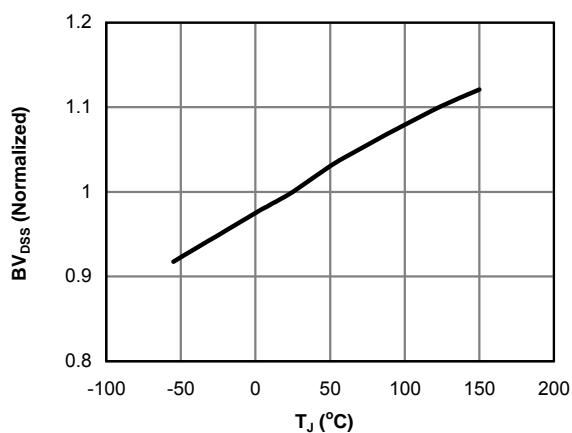
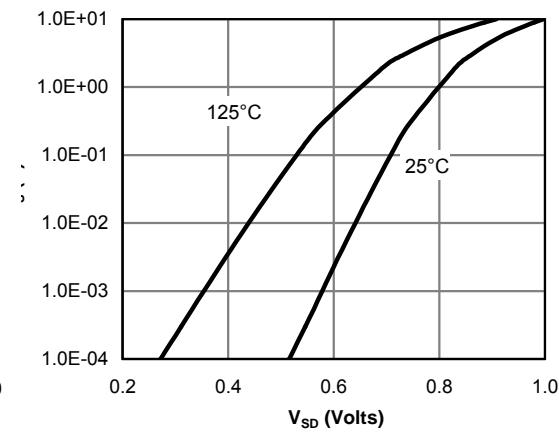
E. The static characteristics in Figures 1 to 6 are obtained using <300  $\mu\text{s}$  pulses, duty cycle 0.5% max.

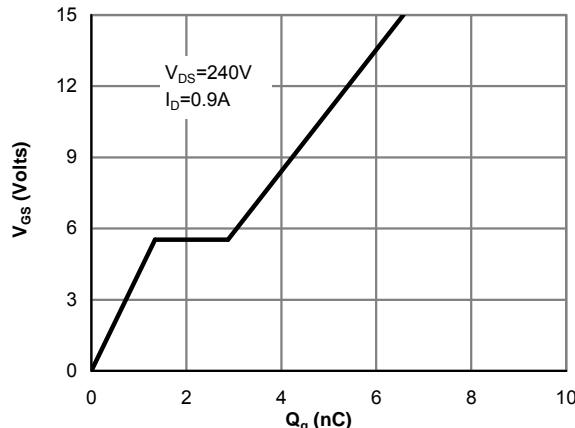
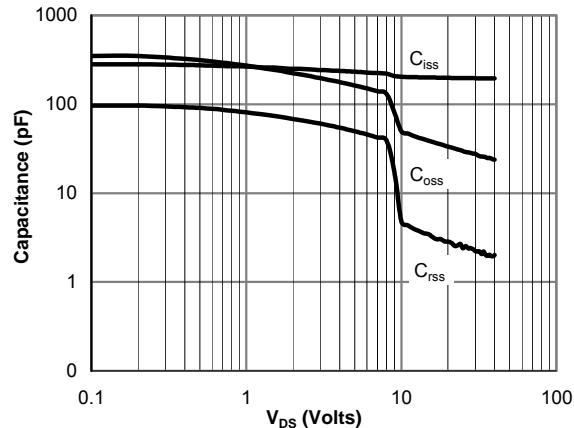
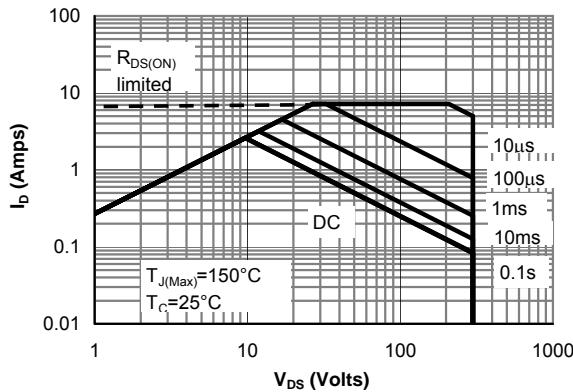
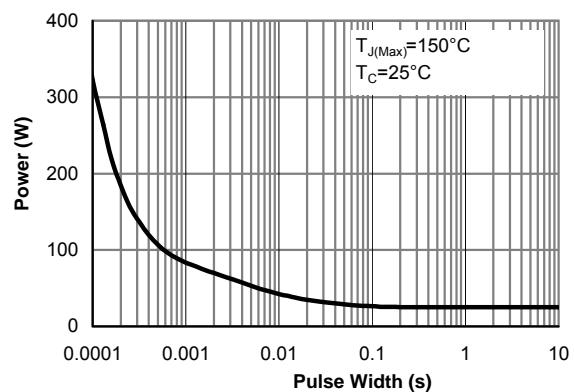
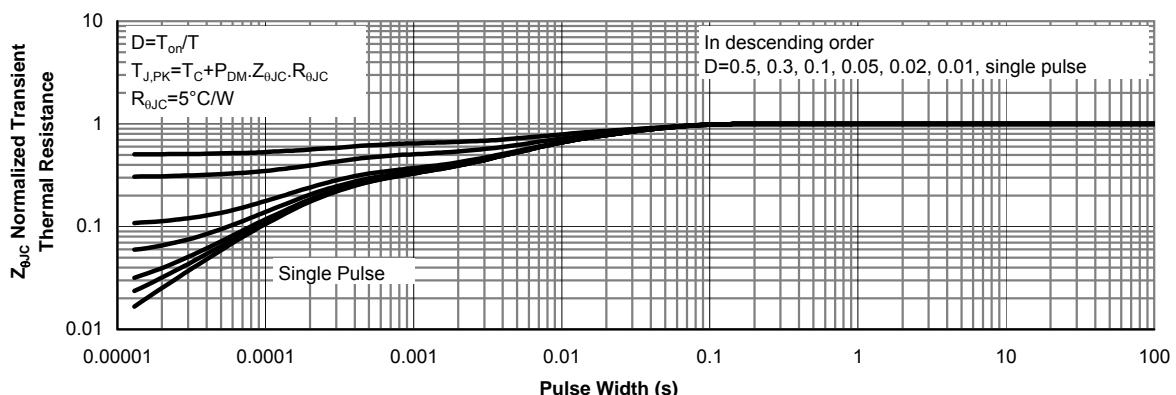
F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of  $T_{J(\text{MAX})}=150^\circ\text{C}$ . The SOA curve provides a single pulse rating.

G. These tests are performed with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ .

H.  $L=60\text{mH}, I_{AS}=1.4\text{A}, V_{DD}=150\text{V}, R_G=10\Omega$ , Starting  $T_J=25^\circ\text{C}$

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**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**

**Figure 1: On-Region Characteristics**

**Figure 2: Transfer Characteristics**

**Figure 3: On-Resistance vs. Drain Current and Gate Voltage**

**Figure 4: On-Resistance vs. Junction Temperature**

**Figure 5: Break Down vs. Junction Temperature**

**Figure 6: Body-Diode Characteristics**

**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**

**Figure 7: Gate-Charge Characteristics**

**Figure 8: Capacitance Characteristics**

**Figure 9: Maximum Forward Biased Safe Operating Area (Note F)**

**Figure 10: Single Pulse Power Rating Junction-to-Case (Note F)**

**Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)**

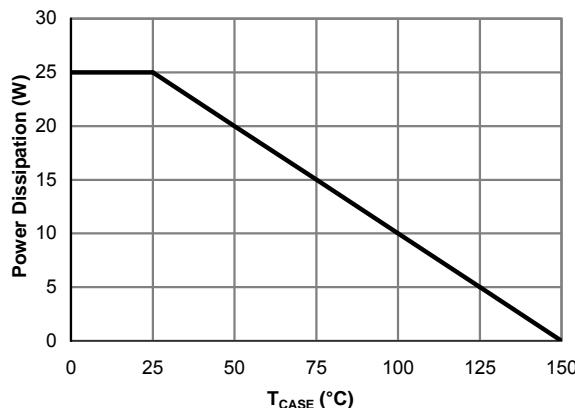
**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**


Figure 12: Power De-rating (Note B)

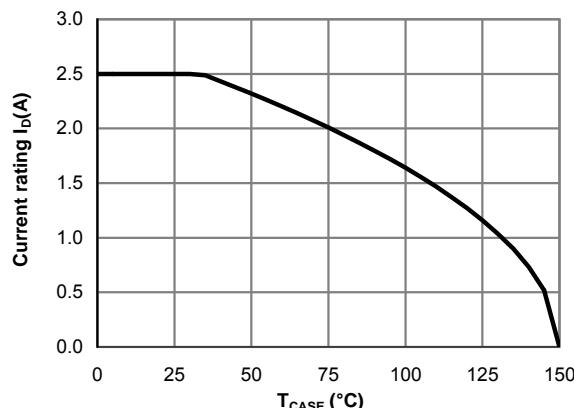


Figure 13: Current De-rating (Note B)

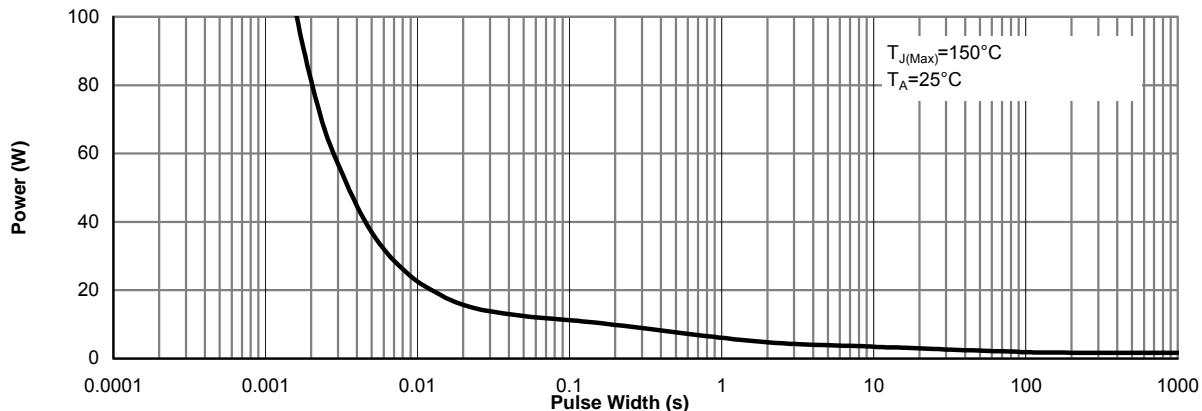


Figure 14: Single Pulse Power Rating Junction-to-Ambient (Note G)

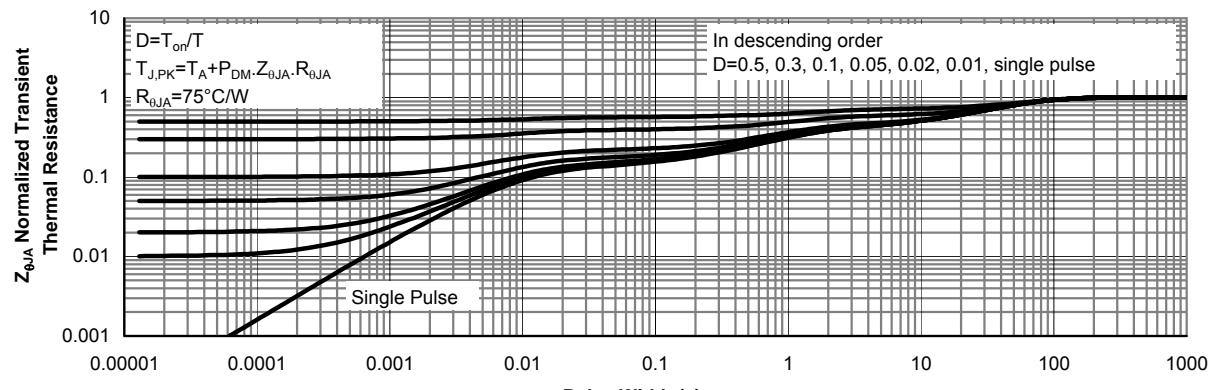
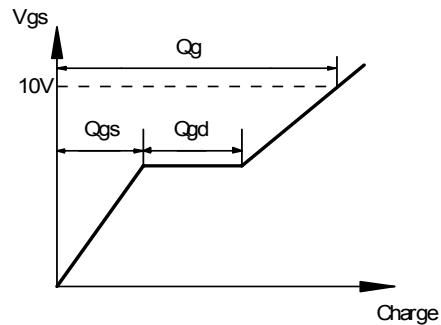
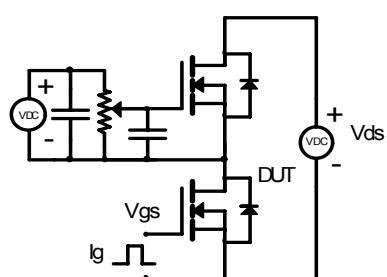
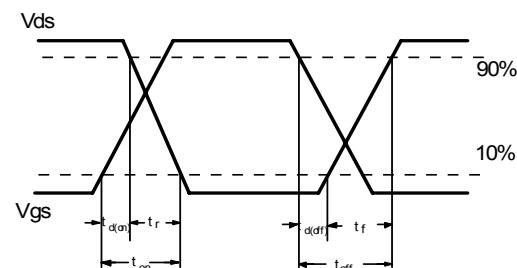
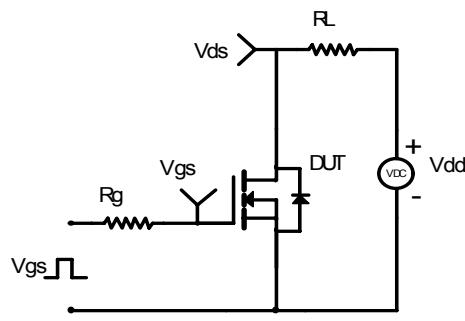


Figure 15: Normalized Maximum Transient Thermal Impedance (Note G)

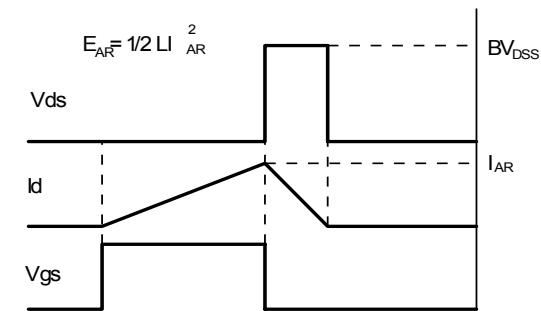
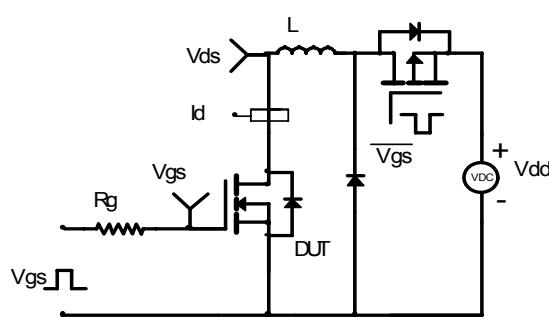
Gate Charge Test Circuit &amp; Waveform



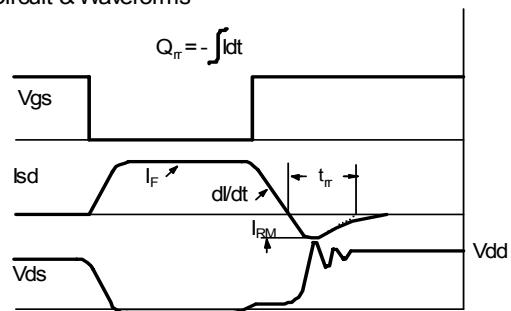
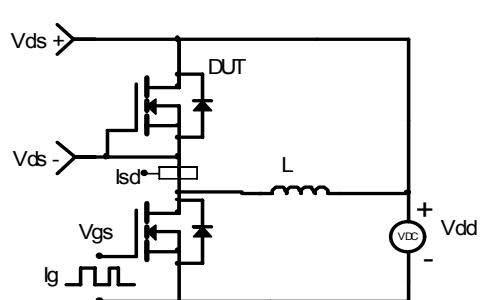
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